



Benefactor Opportunities

The 22nd International Conference on
Solid-State Sensors, Actuators, and Microsystems



Dear Colleagues,

With great pleasure we invite you to join us at the 22nd International Conference on Solid-State Sensors, Actuators, and Microsystems to be held under the Institute of Electrical Engineers of Japan at the Kyoto International Conference Center (Kyoto) from June 25 to 29, 2023.

As electronic systems become more sophisticated, sensors and actuators that interface with the outside world have become indispensable technologies. Sensors that convert various physical, chemical, and biological information into electrical signals, and microsystems that integrate them with processors and actuators, have brought great benefits to society and industry, in areas such as small electronic devices, IoT, environmental monitoring, automobiles, and medical and welfare applications.

The first meeting on the theme of sensor technology was held in Boston, USA, in 1981. Since then this international conference has been held every two years, rotating among North America, Asia, and Europe. As the largest international conference in this field, the number of attendees has been increasing every year, and the 20th conference held in Berlin, Germany in June 2019 attracted more than 1,400 participants from all over the world. In Japan, the conference has been held three times before, in Tokyo in 1987, Yokohama in 1993, and Sendai in 1999. The Kyoto conference in 2023 will be the first in 24 years since the Sendai conference. Due to the spread of COVID, the 21st conference in 2021 was held entirely online, and the Kyoto conference will be the first face-to-face conference in four years since the 2019 conference in Berlin.

In addition to providing a forum for the exchange of information on cutting-edge technologies and knowledge, it will also foster good international relations through various exchanges among the participants. For students and young researchers in Japan, it is an excellent opportunity to come into close contact with the world's most advanced academic gatherings. For industry, it will be an excellent opportunity to obtain cutting-edge information on technological trends, application developments, and market directions, with a view to practical application.

With great pleasure we invite you to join this exciting event as a benefactor to support the community for the future development. We are offering different levels of sponsorship and benefactor opportunities for your organization to be a part of this event. We sincerely hope we will meet in Kyoto in June 2023.

Satoshi Konishi
General Chair
TRANSDUCERS 2023



Conference Outline

Name of event	The 22nd International Conference on Solid-State Sensors, Actuators and Microsystems (TRANSDUCERS 2023)
Objective	The purpose of the conference is to provide an international forum for the reporting and discussion of the latest research results in the field of sensors, actuator systems and microsystems, thereby contributing to the development of research in this field.
Date:	Sunday June 25 to Thursday June 29 2023
Venue	Kyoto International Conference Center, Kyoto, Japan
Sponsor	The Institute of Electrical Engineers of Japan (IEEJ)
Technical co-sponsor	IEEE MEMS Techniical Community
Supporting Organizations	The Japan Society of Applied Physics, The Society of Chemistry, Micro-and Nano-Systems, The Society of Instrument and Control Engineers, The Society of Systems, Control and Information Engineers, The Next Generation Sensor Council, The Institute of Electronics Packaging, The Japan Society for Precision Engineering, Sensing Technology Application Society, The Institute of Electronics, Information and Communication Engineers, The Japan Society of Mechanical Engineers, The Materials Science Society of Japan, The Vacuum Society of Japan, The Infrared Society of Japan, The Robotics Society of Japan and others The Robotics Society of Japan,
Number of participating countries	Approx. 30
Number of participants:	1,000 (400 from Japan, 600 from overseas)
Number of papers presented:	Approx. 500 (including invited papers)
Registration fee	IEEJ Member: 90,000 yen, Regular: 100,000 yen, Students: 60,000 yen

Schedule of Events

	Morning	Afternoon	Evening
Sunday 25 June	Registration, Special Session 1, Welcome Reception		
Monday 26 June	Opening, Plenary Talk	Poster & Technical Sessions	Special Session
Tuesday 27 June	Plenary Talk, Technical Sessions	Poster & Technical Sessions	Special Session
Wednesday 28 June	Plenary Talk, Technical Sessions	Poster & Technical Sessions	Conference Banquet
Thursday 29 June	Plenary Talk, Technical Sessions Awards Ceremony & Closing		

Benefactor Categories and Benefits

Sponsor Category Yokozuna 5,000,000 yen	Banquet Sponsor Company name on the conference bag 2 free registrations Free exhibit booth PR video streamed during breaks Logo display on Zoom wallpaper and background panel
Sponsor Category Ozeki 2,500,000 yen	Sunday Welcome Sponsor Company name on the conference bag 1 free registration Free exhibit booth PR video streamed during breaks Logo display on Zoom wallpaper and background panel
Sponsor Category Sekiwake 1,000,000 yen	Coffee Break Sponsor (for one coffee break) Company name on the conference bag 1 free registration 50% discount on booth exhibit PR video streamed during breaks Logo display on Zoom wallpaper and background panel
Sponsor Category Komusubi 500,000 yen	Company name on the conference bag 1 free registration 25% discount on booth exhibit Logo display on Zoom wallpaper and background panel
Sponsor Category Juryo 250,000 yen	1 free registration 25% discount on booth exhibit Logo display on Zoom wallpaper and background panel
Sponsor Category Maku-uchi 100,000 yen	Logo display on Zoom wallpaper and background panel
Industry Lunch Sponsor 200,000 yen	Time for corporate PR during lunch break Logo display on Zoom wallpaper and background panel
Exhibit only 250,000 yen	1 free registration Logo display on Zoom wallpaper and background panel

	Banquet Sponsor	Sunday Welcome Sponsor	Coffee Break Sponsor	Company name on the conference bag	Free registration	Free exhibit booth	50% discount on booth exhibit	25% discount on booth exhibit	Video streamed during breaks	Zoom wallpaper	Logo display on Zoom wallpaper and background panel
Yokozuna 5,000,000 yen	●	-	-	●	2	●	-	-	●	●	●
Ozeki 2,500,000 yen	-	●	-	●	1	●	-	-	●	●	●
Sekiwake 1,000,000 yen	-	-	●	●	1	-	●	-	●	●	●
Komusubi 500,000 yen	-	-	-	●	1	-	-	●	-	●	●
Juryo 250,000 yen	-	-	-	-	1	-	-	●	-	●	●
Maku-uchi 100,000 yen	-	-	-	-	-	-	-	-	-	●	●
Lunch Sponsor 200,000 yen										●	●
Exhibit only 250,000 yen	-	-	-	-	1	-	-	-	-	●	●

Exhibition

Exhibition	Device-related and applied system products, design tools, manufacturing equipment, measurement instruments, materials, mounting technology, books, and others
Dates:	Afternoon June 25 Set-up Exhibition in Session June 26 to June 28 June 28 Take-down
Number of booths available	40 booths
Booth size	1.8m x 1.8m With back wall and side walls, company name in standard black font, standard lighting, table and 2 chairs Exhibitor may order two connecting booths for larger space
Exhibitor Benefits	1 free registration Logo display on Zoom wallpaper and background panel Company name listed in the Technical Digest ¹ Company name and logo on the Final Program ¹ Company name on the Welcome sign ¹
Exhibitor Fee	250,000 yen per booth

Exhibitor and Benefactor Benefits

All Exhibitors and Sponsorship Levels include the following benefits:

- ✧ Company name listed in the Technical Digest¹
- ✧ Company name and logo on the Final Program¹
- ✧ Company name on the Welcome sign¹
- ✧ Company name and logo on the Conference website with a link to your website
- ✧ Company name and logo on the Opening Slide at the Conference



How to Apply

Please fill out the attached application form and return it to the secretariat by e-mail. Upon receipt of the application, the secretariat will send you an invoice.

Application deadline: April 15, 2023

©Cancellation Policy

If a cancellation request is received by the following date after receipt of the exhibit/sponsorship application form, 50% of the amount paid will be refunded. No refunds will be made for cancellations received after that date. Cancellations must be made in writing (email is also acceptable).

Application – April 15, 2023 · · · · · 50% cancellation fee

After April 16, 2023 · · · · · Cancellation fee 100%.

For Inquiries, contact:

TRANSDUCERS 2023 Secretariat

Tokan Shinjuku Bldg., 603

Nishi-Shinjuku 3-6-5, Shinjuku

Tokyo, 160-0023 Japan

phone: 81-3-3346-8007

email: transducers23-sponsor@conferences.jp

Benefactor Application Form 1

Please fill out this form and send to:
transducers23-sponsor@conferences.jp

Sponsor Category	<input type="checkbox"/> Yokozuna	5,000,000 yen
	<input type="checkbox"/> Ozeki	2,500,000 yen
	<input type="checkbox"/> Sekiwake	1,00,000 yen
	<input type="checkbox"/> Komusubi	500,000 yen
	<input type="checkbox"/> Juryo	250,000 yen
	<input type="checkbox"/> Maku-uchi	100,000 yen
	<input type="checkbox"/> Lunch Sponsor	200,000 yen
	<input type="checkbox"/> Exhibit only	250,000 yen

Name of Organization

The name will appear on the website and in the program book

Contact Person

Name :

Address 1 :

Address 2

Phone :

Fax :

E-mail :

Corporate URL

We will provide link from the conference website

Corporate Logo

Please provide the corporate logo in JPG file (Max. 60 px x 160 px)

If you wish to exhibit as listed above, please also fill out and return Exhibition Application Form.

Exhibition Application Form

Please fill out this form and send to:
 transducers23-sponsor@conferences.jp

Organization Name		
	In Japanese (If available)	
	Address	
	Phone	Fax
Contact Person	Name	
	Address	
	Phone	Fax
	E-mail	
Number of Booths	booth (s)	
Description of Exhibit	Please describe the items or products you wish to exhibit.	
Electricity Requirement	Equipment to be used : Number or Electrical Outlets required:	
Outside Vendor for Booth Setting	If you plan to contract outside vendor, please let us know. Name of Company: Contact Information:	
Other Remarks	If you have additional requirements for the booth, please let us know. Example: High table, brochure rack, etc.	